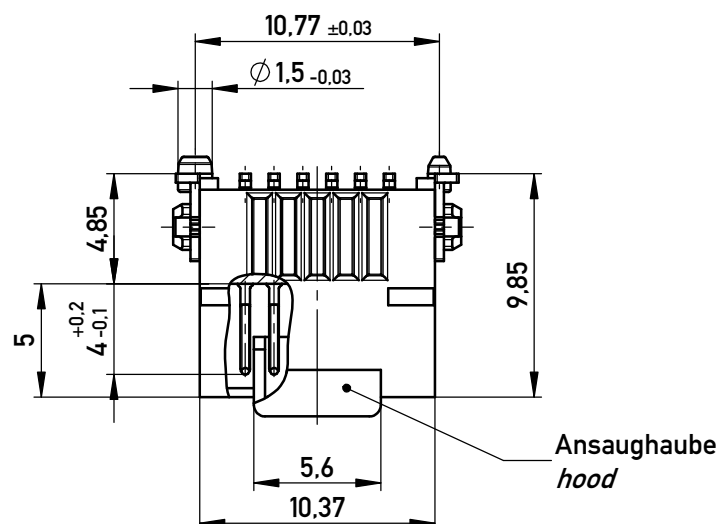
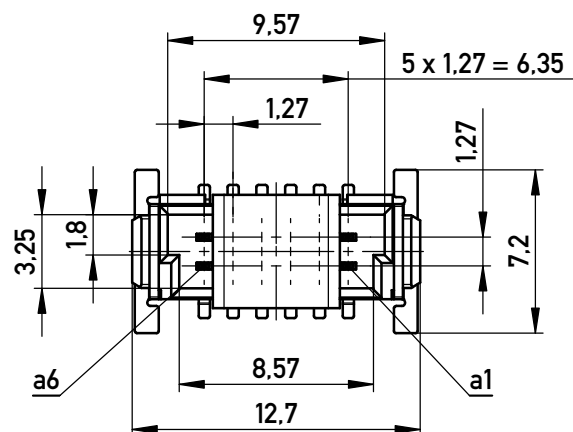
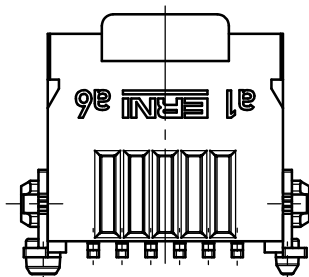
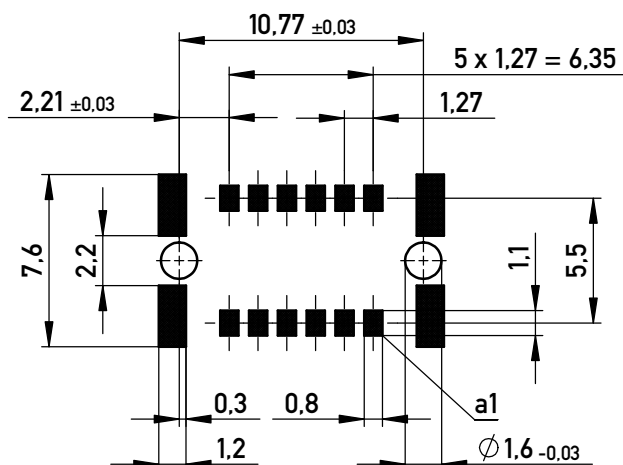


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



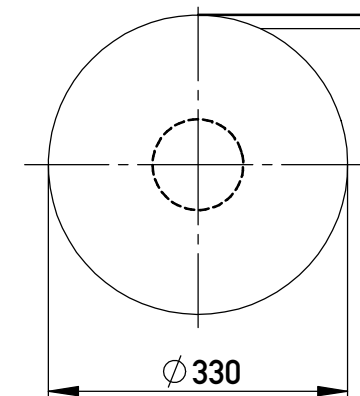
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

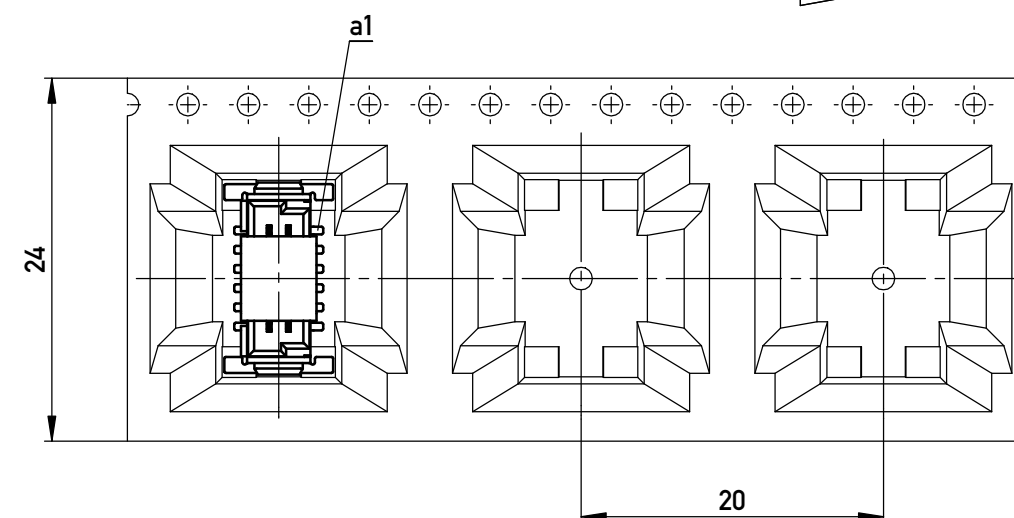
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 250 Stück
Packaging unit: 250 pcs



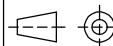
Abspulrichtung - Reel off Direction



BA 8-23 hohe Bauhöhe

type 8-23 High Profile

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Information:			Tolerances	 All Dimensions in mm	Scale 3:1		
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					Messerl. SMC-Q 12-SMD-BA8-23 Male SMC-Q 12-SMD-type8-23		
			www.ERNI.com		234206		I
e		26.06.2015					A3
Index		Date			Class	SMCQ	

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